N	M	M	&	0	Docket	No.
14.	747	TAT	Ų.	$\mathbf{\circ}$	DOCKCE	110

Declaration For U.S. Patent Application

		or C.D. 1 at	int application	•				
As a below named in	nventor, I hereby declare that:							
My residence, post	office address and citizenship a	re as stated below my nan	16. halaw) or an original first and	igint inventor (if alvest				
I believe I am the or	iginal, first and sole inventor (i	is claimed and for which	a patent is sought on the inver	joint inventor (ii piurai				
Ansart Title) PLA	SMA DENSITY INFORMA	TION MEASURING N	ETHOD, PROBE USED I	FOR MEASURING				
PLASMA DENS	SITY INFORMATION, AN	D PLASMA DENSITY	INFORMATION MEASUR	RING APPARATUS				
	which is attached hereto unless			1				
the specification of	winch is attached hereto unless	the following box is enece	acu.					
	was filed on	as United Sta	ates Application Number or PC	CT International				
	Application Number			(if applicable).				
I hereby state that I l	have reviewed and understand th	e contents of the above-ide	entified specification, including	the claim(s), as amended				
by any amendment								
I acknowledge the d	luty to disclose information whi	ch is material to patentabi	ility as defined in 37 C.F.R. §1	1.56.				
I hereby claim foreign	n priority benefits under 35 U.S	S.C. §119(a)-(d) or §365(1	b) of any foreign application(s)	for patent or inventor's				
certificate, or §365(a	a) of any PCT International appl	ication which designated	at least one country other than	the United States, listed				
below and have also	identified below any foreign app	dication for patent or inver	itor's certificate or PC1 internal	nonai Application naving				
a ming date before	that of the application(s) for wh	_	-22 (7 (1000	Priority Claimed				
(List prior	10-208129(P)	<u>Japan</u>	23/7/1998	⊠ Yes □ No				
foreign	(Number) II-58636(P)	(Country) Japan	(Day/Month/Year Filed) .5/3/1999	⊠ Yes □ No				
applications. See note A	(Number)	(Country)	(Day/Month/Year Filed)	2103 2110				
See note A on back of	(Tumber)			□ Yes □ No				
this page)	(Number)	(Country)	(Day/Month/Year Filed)					
	E	of any Timitad States and	vicional application(s) listed be	alow				
94 K	penefit under 35 U.S.C. §119(e)	of any Officed States pro	visional application(s) listed be	Now.				
F6 63								
**	(Application Number)	(Filing Da	te)					
in .	(A aliania Namban)	(Filing Da	***					
	(Application Number)	(Filling Da	iie)					
eii (See Note B on bac	k ☐ See attached	list for additional prior fo	reign or provisional application	ns.				
of this page)		•	5 1					
ni:	enefit under 35 U.S.C. §120 of	any I Inited States applicati	on(s) or \$265(s) of any PCT Int	ternational application(s)				
in hereby claim the Unit	ed States of America listed below	any United States applicati a and incofar as the subje	ct matter of each of the claims	of this application is not				
disclosed in the price	or application(s) (U.S. or PCT) is	n the manner provided by	the first paragraph of 35, U.S.	.C. §112, I acknowledge				
the duty to disclose	information which is material to	patentability as defined in	n 37 C.F.R. §1.56 which becar	ne available between the				
filing date of the pr	ior application and the national	or PCT International filing	ng date of this application.					
(List prior U.S.								
Applications or	(Application Serial No.)	(Filing Date)	(Status) (patented, patented)	pending, abandoned)				
PCT International applications		(Millian Dana)	(Constant of a	anding shandaned)				
designating the U.S.)	(Application Serial No.)	(Filing Date)	(Status) (patented,)	(Status) (patented, pending, abandoned)				
And I hereby appoin	nt as principal attorneys David T	. Nikaido, Reg. No. 22,66	63; Charles M. Marmelstein, R	leg. No. 25,895; George				
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Richard J. Berman	, Reg. No. 39,107.							
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		1 11	I shot all attachments and do	on information and haliaf				
I hereby declare tha	it all statements made herein of r rue; and further, that these state	ny own knowledge are tru	e and that an statements made (statements and the like so				
made are punishahi	e by fine or imprisonment, or bo	oth under Section 1001 of	Title 18 of the United States C	code and that such willful				
	by jeopardize the validity of the			(Day/Month/Year)				
100 0	-, , , , , , , , , , , , , , , , , , , 			(===2,==== , ,				
(See Note C	Full name of sole or first in	ventor Hideo SUGA	XI					
on back of		11/1/12	u a	July 2, 1999				
this page)	Date							
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Inventor's signature	Date
Residence	Date
Citizenship	
Post Office Address	
Full name of seventh joint inventor, if any	
Inventor's signature	Date
Residence	Date
Citizenship	
Post Office Address	
Full name of eighth joint inventor, if any	
Inventor's signature	-
Residence	Date
Citizenship	
Post Office Address	